

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Tu-Yen Huang</td> <td>03/27/2007</td> </tr> <tr> <td>Yi-Hong Chen</td> <td>03/28/2007</td> </tr> <tr> <td>Ta-Chin Lee</td> <td>03/27/2007</td> </tr> <tr> <td>Shang-Sheng Wu</td> <td>03/27/2007</td> </tr> <tr> <td>Chiun-Tong Su</td> <td>03/27/2007</td> </tr> </tbody> </table>		Name	Execution Date	Tu-Yen Huang	03/27/2007	Yi-Hong Chen	03/28/2007	Ta-Chin Lee	03/27/2007	Shang-Sheng Wu	03/27/2007	Chiun-Tong Su	03/27/2007
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RECEIVING PARTY DATA													
Name:	Taiwan Semiconductor Manufacturing Co., Ltd.												
Street Address:	No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park												
City:	Hsin-Chu												
State/Country:	TAIWAN												
Postal Code:	300-77												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12859541</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12859541								
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CORRESPONDENCE DATA													
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OP \$40.00 12859541

Total Attachments: 2
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ASSIGNMENT

WHEREAS, Tu-Yen HUANG, Yi-Hong CHEN, Da-Chin LEE, Shang-Sheng WU and Chiun-Tong SU hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: ETCHING SYSTEM

Filed: _____ Serial No. _____

Executed on: March 27, 2007 and March 28, 2007

WHEREAS, Taiwan Semiconductor Manufacturing Co., Ltd. of No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

黃 達 敬

Tu-Yen HUANG

3/27/07'

Date:

陳 春 弘

Yi-Hong CHEN

3/28/07'

Date:

李 大 慶

~~Da-Chin LEE~~

Ta-chin Lee 李大慶 李慶雲 李慶雲

3/27/07'

Date:

吳 上 昇

Shang-Sheng WU

3/27/07'

Date:

蘇 祥 統

Chiun-Tong SU

3/27/07'

Date:

TSMC2006--0832/0503-A32793US